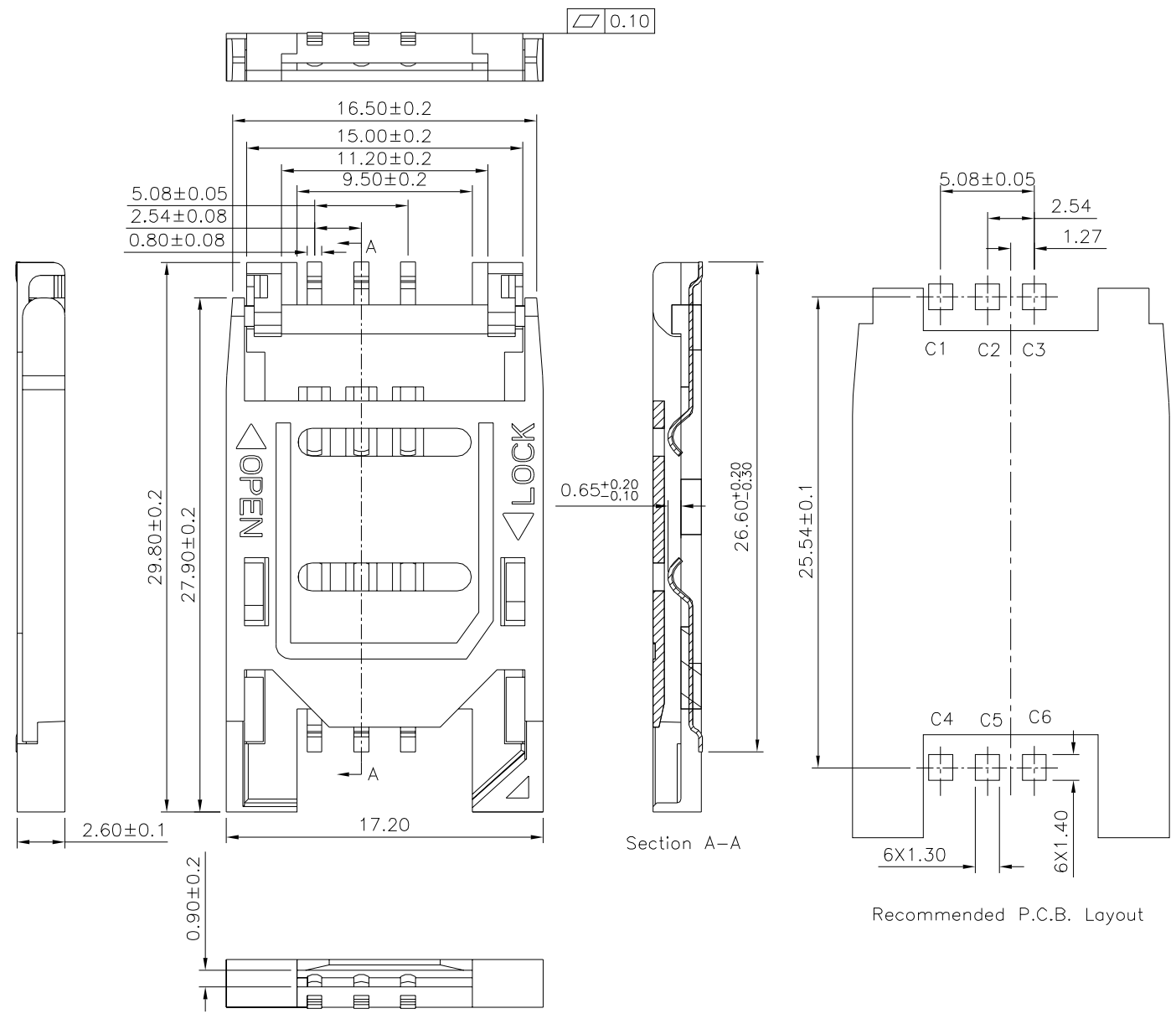


**SPECIFICATION**

- 1.General Characteristics**  
SIM Card 06P Hinged Cover Type SMT  
90°,Without Locating Peg Without  
Switch,Row Pitch=A Type,H=2.6mm  
Selective Gold Flash Tape&Reel 800 PCS/Reel
- 2.Material&Finish**  
Base:LCP(UL94V-0),Black  
Cover:LCP(UL94V-0),Black  
Contact:Phosphor Bronze,Gold Flash On Contact  
Area,Tin Plated On Solder Tails,Over Nickel
- 3.Electrical Characteristics**  
Contact Resistance:50 Milliohms Initial,  
100 Milliohms Max.  
Insulation Resistance:1000 Megaohms Min.  
At 500V DC
- 4.Mechanical Characteristics**  
Durability:5000 Cycles Min.
- 5.Environmental Characteristics**  
Operating Temperature:-40°C~+85°C  
Operating Humidity:10%~+95%RH  
Storage Temperature:-40°C~+85°C  
Storage Humidity:10%~+95%RH  
Thermal Shock:-40°C~+85°C,5Cycles.  
Damp Heat:40°C,90%RH,10 Days.  
Salt-Mist:35°C,5%Nacl,24H
- 6.RoHS Compliant**



**4UCON** 元化興業股份有限公司  
4UCON TECHNOLOGY INC.

DRAWING No.		APPROVED BY		UNLESS OTHERWISE SPECIFIED TOLERANCES ARE X. ±0.30 X ±0.20 .XX ±0.15 .XXX ±0.10 ANG. ±2°
19194		MEI		
		HZF		
		DRAWING BY		
		CYP		
SCALE	NONE	REV.	A0	UNIT mm

△ A0	NEW RELEASE	HZF	04/19/2017
NO.REV.	REVISIONS	CHK	DATE